Qualcom

RF360 Europe GmbH

Data sheet

SAW duplexer LTE / 5G band 7

Part number:B1261Ordering code:B39272B1261P810

Date: Version: November 10, 2020 2.7

DCN: 80-PA243-345 Rev. H

RF360 products mentioned within this document are products of RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the "RF360 Subsidiaries").

RF360 Europe GmbH, Anzinger Str. 13, München, Germany © 2020 RF360 Europe GmbH and/or its affiliated companies. All rights reserved.



These materials, including the information contained herein, may be used only for informational purposes by the customer. The RF360 Subsidiaries assume no responsibility for errors or omissions in these materials or the information contained herein. The RF360 Subsidiaries reserve the right to make changes to the product(s) or information contained herein without notice. The materials and information are provided on an AS IS basis, and the RF360 Subsidiaries assume no liability and make no warranty or representation, either expressed or implied, with respect to the materials, or any output or results based on the use, application, or evaluation of such materials, including, without limitation, with respect to the non-infringement of trademarks, patents, copyrights or any other intellectual property rights or other rights of third parties.

No use of this documentation or any information contained herein grants any license, whether express, implied, by estoppel or otherwise, to any intellectual property rights, including, without limitation, to any patents owned by QUALCOMM Incorporated or any of its subsidiaries.

Not to be used, copied, reproduced, or modified in whole or in part, nor its contents revealed in any manner to others without the express written permission of RF360 Europe GmbH.

Qualcomm is a trademark of Qualcomm Incorporated, registered in the United States and other countries. Other product and brand names may be trademarks or registered trademarks of their respective owners.

This technical data may be subject to U.S. and international export, re-export, or transfer ("export") laws. Diversion contrary to U.S. and international law is strictly prohibited.

Table of contents

| Application. | 4 |
|-----------------------------|----|
| Peatures | 4 |
| B Package | 5 |
| Pin configuration | 5 |
| Matching circuit | 6 |
| Characteristics | |
| Maximum ratings | |
| 3 Transmission coefficients | |
| Reflection coefficients | |
| 0 Packing material | 16 |
| 1 Marking | |
| 2 Soldering profile | 21 |
| 3 Annotations | 22 |
| 4 Cautions and warnings | 23 |
| 5 Important notes | 24 |

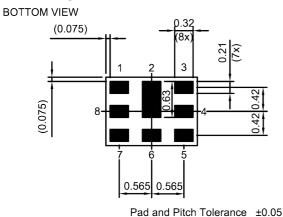
1 Application

- Duplexer for 4G and 5G Band 7
- LTE band 7 uplink: 2535 MHz (pass band 70 MHz)
- LTE band 7 downlink: 2655 MHz (pass band 70 MHz)
- Qualcomm® micro-Acoustic Power Management (MAPM)
- Low insertion attenuation
- Low amplitude ripple

2 Features

- Package size 1.6±0.05 mm × 1.2±0.05 mm
- Package height 0.5 mm (max.)
- Approximate weight 4 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

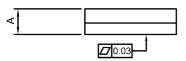
3 Package

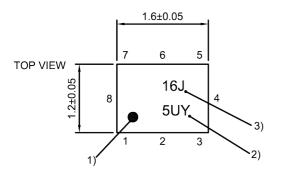


Pin configuration 4

- 1 RX
- 3 ТΧ
- ANT **6**
- **■** 2, 4, 5, 7, Ground 8

SIDE VIEW





1) Marking for pad number 1

- 2) Example of encoded lot number
- 3) Example of encoded filter type number

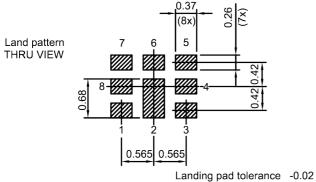


Figure 1: Drawing of package with package height A = 0.5 mm (max.). See Sec. Package information (p. 23).

November 10, 2020



5 Matching circuit

■ *L*_{p6} = 2.5 nH

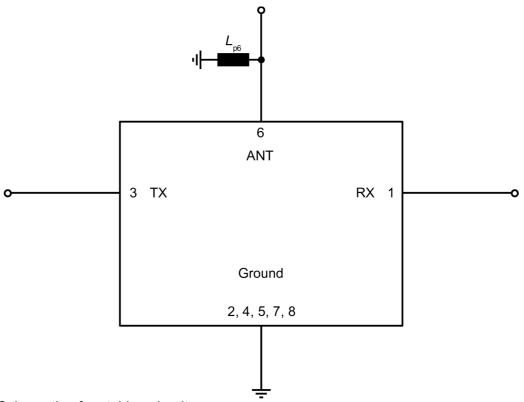


Figure 2: Schematic of matching circuit.

External shunt inductor for ESD protection is recommended at any ports towards antenna.

6 Characteristics

6.1 TX – ANT

| Temperature range for specification | $T_{_{\rm SPEC}}$ | = −30 °C +85 °C |
|-------------------------------------|-------------------|--------------------------------|
| TX terminating impedance | Z _{TX} | = 50 Ω |
| ANT terminating impedance | Z | = 50 Ω // 2.5 nH ¹⁾ |
| RX terminating impedance | Z _{RX} | = 50 Ω |

| Characteristics TX – ANT | | | | min. for $T_{\rm SPEC}$ | typ. @ +25 °C | max. for $T_{\rm SPEC}$ | |
|-------------------------------|-----------------|-----|-----------------------------|----------------------------|-------------------------|-------------------------|-----|
| Center frequency | | | f _c | — | 2535 | — | MHz |
| Maximum insertion attenuation | | | $\alpha_{_{max}}$ | | | | |
| | 2500.25 2569.75 | MHz | | _ | 1.4 | 2.4 | dB |
| Amplitude ripple (p-p) | | | Δα | | | | |
| | 2500.25 2569.75 | MHz | | _ | 0.6 | 1.6 | dB |
| Maximum VSWR | | | $VSWR_{_{max}}$ | | | | |
| @ TX port | 2500.25 2569.75 | MHz | | _ | 1.5 | 2.0 | |
| @ ANT port | 2500.25 2569.75 | MHz | | _ | 1.5 | 2.0 | |
| Average attenuation | | | $lpha_{_{WLAN,avg}}^{~~2)}$ | | | | |
| Wi-fi Channel 1 | 2403 2421 | MHz | | 42 | 49 | _ | dB |
| Wi-fi Channel 2 | 2408 2426 | MHz | | 42 | 48 | _ | dB |
| Wi-fi Channel 3 | 2413 2431 | MHz | | 40 | 47 | _ | dB |
| Wi-fi Channel 4 | 2418 2436 | MHz | | 40 | 46 | _ | dB |
| Wi-fi Channel 5 | 2423 2441 | MHz | | 40 | 45 | _ | dB |
| Wi-fi Channel 6 | 2428 2446 | MHz | | 40 | 45 | _ | dB |
| Wi-fi Channel 7 | 2433 2451 | MHz | | 40 | 46 | — | dB |
| Wi-fi Channel 8 | 2438 2456 | MHz | | 40 | 48 | — | dB |
| Wi-fi Channel 9 | 2443 2461 | MHz | | 40 | 46 | — | dB |
| Wi-fi Channel 10 | 2448 2466 | MHz | | 32 | 48 | — | dB |
| Wi-fi Channel 11 | 2453 2471 | MHz | | 10 | 40 | _ | dB |
| Wi-fi Channel 12 | 2458 2476 | MHz | | 5 | 25 | — | dB |
| Wi-fi Channel 13 | 2463 2481 | MHz | | 3 | 13 | — | dB |
| Minimum attenuation | | | $\alpha_{_{min}}$ | | | | |
| | 10 1559 | MHz | | 35 | 41 | _ | dB |
| | 1559 1563 | MHz | | 35 | 41 | _ | dB |
| | 1565.42 1573.37 | MHz | | 35 | 41 | _ | dB |
| | 1573.37 1577.47 | MHz | | 35 | 41 | _ | dB |
| | 1577.47 1585.42 | MHz | | 35 | 41 | — | dB |
| | 1597.56 1605.89 | MHz | | 35 | 40 | — | dB |
| | 1605.89 1680 | MHz | | 35 | 39 | — | dB |
| | 1805 1880 | MHz | | 35 | 37 | — | dB |
| | 1900 1920 | MHz | | 34 | 37 | — | dB |
| | 2010 2025 | MHz | | 32 | 37 | — | dB |
| | 2110 2170 | MHz | | 32 | 38 | — | dB |

Page 7 of 24

| Characteristics TX – ANT | | | $\begin{array}{c} {\rm min.} \\ {\rm for} \ {\rm T_{_{\rm SPEC}}} \end{array}$ | typ. @ +25 °C | max. for T _{SPEC} | |
|--------------------------|-----------------|-----|--|-------------------------|-------------------------------|----|
| | 2402 2440 | MHz | 40 | 45 | — | dB |
| | 2440 2460 | MHz | 40 | 45 | _ | dB |
| | 2620.25 2689.75 | MHz | 37 | 53 | | dB |
| | 3300 3800 | MHz | 30 | 36 | _ | dB |
| | 4900 5000 | MHz | 40 | 46 | _ | dB |
| | 5000 5140 | MHz | 38 | 45 | _ | dB |
| | 5150 5925 | MHz | 35 | 42 | _ | dB |
| | 7500 7710 | MHz | 29 | 34 | _ | dB |

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Average over each WLAN channel with band width of 18 MHz.

6.2 ANT – RX

| Temperature range for specification | $T_{_{\rm SPEC}}$ | = −30 °C +85 °C |
|-------------------------------------|-------------------|--------------------------------|
| TX terminating impedance | Z _{TX} | = 50 Ω |
| ANT terminating impedance | Z | = 50 Ω // 2.5 nH ¹⁾ |
| RX terminating impedance | Z _{RX} | = 50 Ω |

| Characteristics ANT – RX | | | | $\begin{array}{c} {\rm min.} \\ {\rm for} \ {\rm T_{_{\rm SPEC}}} \end{array}$ | typ. @ +25 °C | max. for $T_{\rm SPEC}$ | |
|-------------------------------|-----------------|-----|-------------------|--|-------------------------|-------------------------|-----|
| Center frequency | | | f _c | — | 2655 | | MHz |
| Maximum insertion attenuation | | | $\alpha_{_{max}}$ | | | | |
| | 2620.25 2689.75 | MHz | | _ | 1.7 | 2.6 | dB |
| Amplitude ripple (p-p) | | | Δα | | | | |
| | 2620.25 2689.75 | MHz | | _ | 0.6 | 1.5 | dB |
| Maximum VSWR | | | $VSWR_{max}$ | | | | |
| @ ANT port | 2620.25 2689.75 | MHz | | _ | 1.6 | 2.0 | |
| @ RX port | 2620.25 2689.75 | MHz | | _ | 1.6 | 2.0 | |
| Minimum attenuation | | | $\alpha_{_{min}}$ | | | | |
| | 10 718 | MHz | | 50 | 57 | — | dB |
| | 45 | MHz | | 50 | 105 | — | dB |
| | 718 748 | MHz | | 47 | 56 | — | dB |
| | 814 849 | MHz | | 47 | 54 | — | dB |
| | 832 862 | MHz | | 45 | 53 | — | dB |
| | 880 915 | MHz | | 45 | 52 | — | dB |
| | 1710 1785 | MHz | | 40 | 42 | — | dB |
| | 1920 1980 | MHz | | 35 | 40 | — | dB |
| | 2400 2500 | MHz | | 35 | 43 | — | dB |
| | 2500.25 2569.75 | MHz | | 45 ²⁾ | 55 | | dB |
| | 2500.25 2569.75 | MHz | | 42 | 55 | | dB |
| | 2775 2790 | MHz | | 40 | 56 | — | dB |
| | 2790 2810 | MHz | | 40 | 50 | — | dB |
| | 2810 3660 | MHz | | 38 | 42 | — | dB |
| | 3600 4900 | MHz | | 38 | 47 | — | dB |
| | 4900 5300 | MHz | | 41 | 52 | — | dB |
| | 5300 5950 | MHz | | 38 | 48 | | dB |
| | 7620 7830 | MHz | | 20 | 28 | — | dB |

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Valid for typical temperature T = +25 °C.

TX – RX 6.3

| Temperature range for specification | T _{SPEC} | = −30 °C +85 °C |
|-------------------------------------|-------------------|--------------------------------|
| TX terminating impedance | Z _{TX} | = 50 Ω |
| ANT terminating impedance | Z | = 50 Ω // 2.5 nH ¹⁾ |
| RX terminating impedance | Z _{RX} | = 50 Ω |

| Characteristics TX – RX | | | min. for $T_{\rm SPEC}$ | typ. @ +25 °C | max. for $T_{\rm SPEC}$ | |
|---|---------------------|-------------------|-------------------------|-------------------------|-------------------------|----|
| Minimum isolation | | $\alpha_{_{min}}$ | | | | |
| | 2500.25 2569.75 MHz | | 53 | 56 | — | dB |
| | 2620.25 2689.75 MHz | | 50 | 56 | _ | dB |
| ¹⁾ See Sec. Matching circuit (p. 6). | | | | | | |

See Sec. Matching circuit (p. 6).

7 **Maximum ratings**

| Storage temperature | $T_{\rm STG}^{(1)} = -40 ^{\circ}{\rm C} \dots +85 ^{\circ}{\rm C}$ | |
|--------------------------|---|--|
| DC voltage | $ V_{\rm DC} = 5.0 \rm V (max.)^{2}$ | |
| ESD voltage | | |
| | V _{ESD} ³⁾ = 50 V (max.) | Machine model. |
| | $V_{\rm ESD}^{4)}$ = 100 V (max.) | Human body model. |
| | $V_{\rm ESD}^{5)}$ = 100 V (max.) | Charged device model. |
| Input power | | |
| @ TX port: 2500 2570 MHz | 31 dBm | Continuous wave for 5000 h @ 50 °C. |
| @ TX port: 2500 2570 MHz | 31 dBm | 5 MHz LTE uplink signal 1RB for 5000 h @ 50 °C. |
| @ TX port: 2500 2570 MHz | 30 dBm | 5 MHz 5G NR (CP-OFDM) 1RB for 5000 h @ 50 °C. |

1) Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

2) 168h Damp Heat Steady State acc. IEC 60068-2-67 Cy.

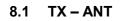
3)

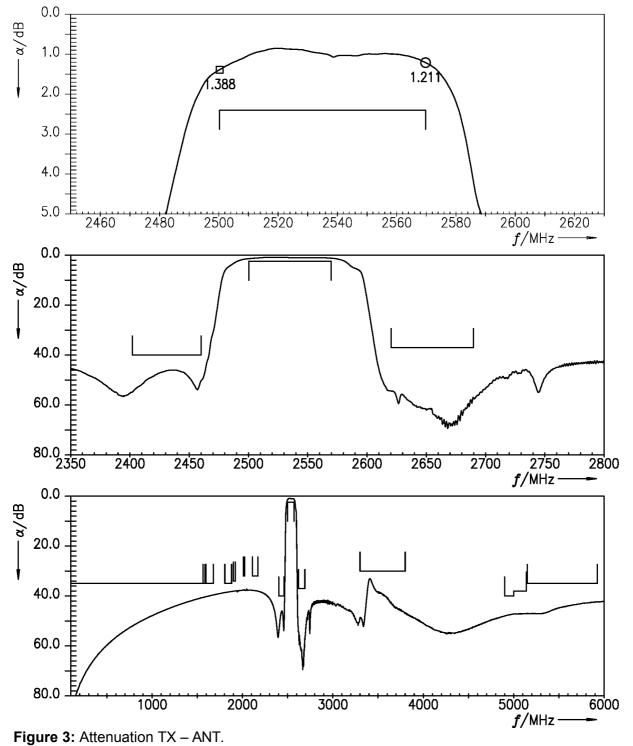
4)

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse. According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses. 5)



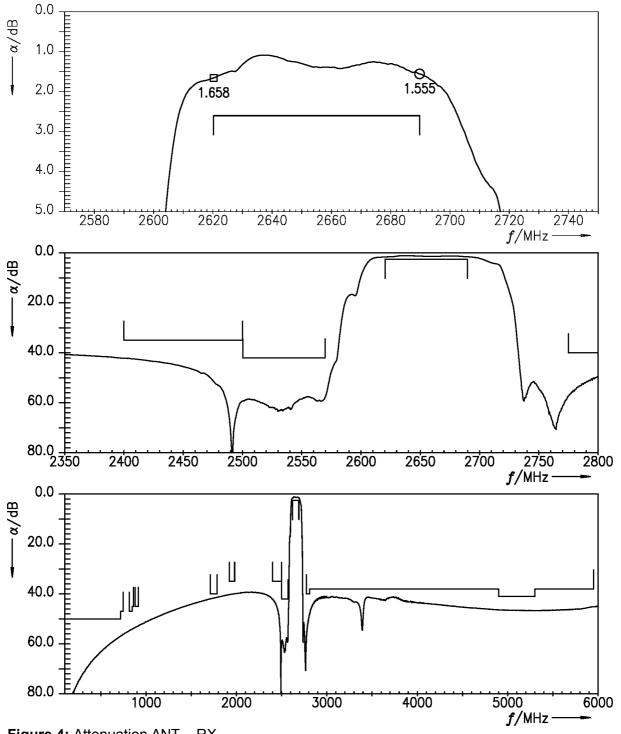
8 Transmission coefficients

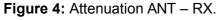




Qualcomm RF360 Europe GmbH

8.2 ANT – RX

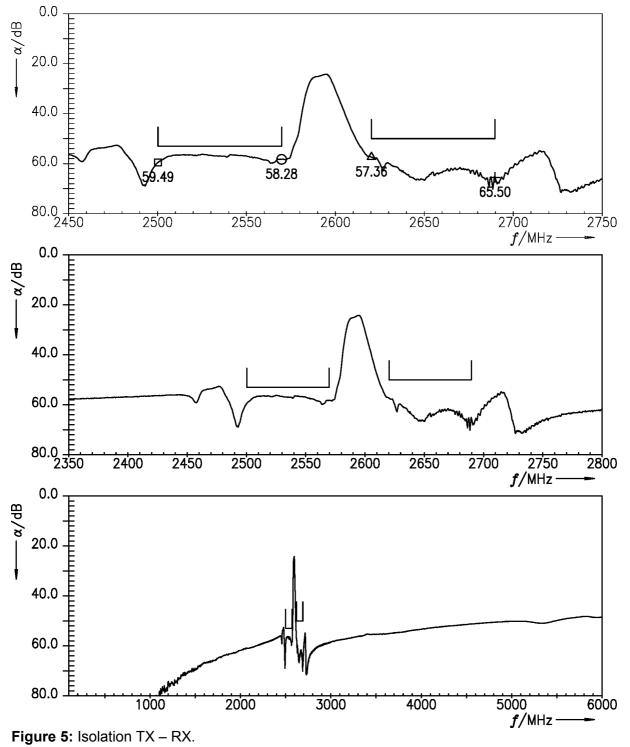




Please read **Cautions and warnings** and **Important notes** at the end of this document.

Qualcomm RF360 Europe GmbH

8.3 TX – RX





□ = 2500.2 O = 2569.8

9 Reflection coefficients

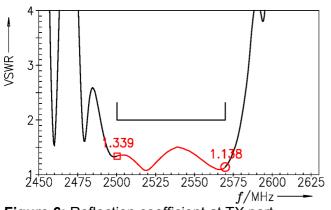


Figure 6: Reflection coefficient at TX port.

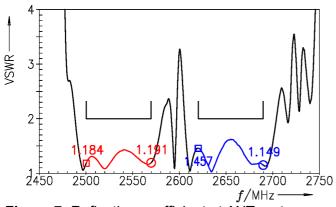
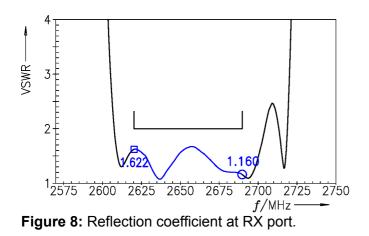
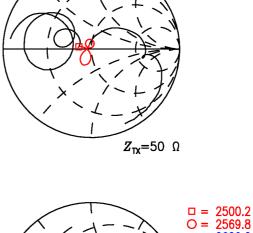
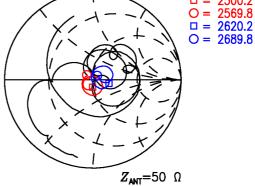
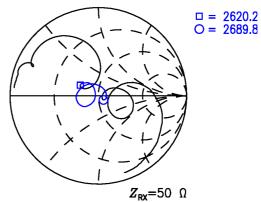


Figure 7: Reflection coefficient at ANT port.





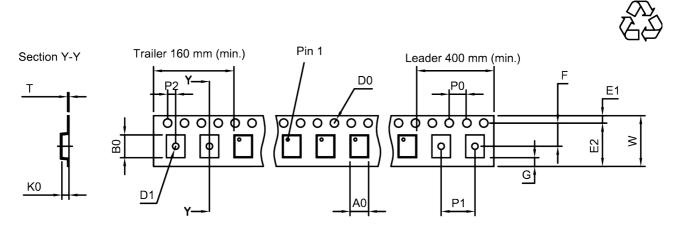






10 Packing material

10.1 Tape



User direction of unreeling

Figure 9: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 A₀
 1.5±0.05 mm

 B₀
 1.9±0.05 mm

 D₀
 1.5±0.1/-0 mm

 D₁
 0.8±0.1/-0 mm

 E₁
 1.75±0.1 mm

Table 1: Tape dimensions.

| E2 | 6.25 mm (min.) |
|----------------|----------------|
| F | 3.5±0.05 mm |
| G | 0.75 mm (min.) |
| K ₀ | 0.63±0.05 mm |
| P ₀ | 4.0±0.1 mm |

| P ₁ | 4.0±0.1 mm |
|----------------|-----------------|
| P ₂ | 2.0±0.05 mm |
| Т | 0.25±0.03 mm |
| W | 8.0+0.3/-0.1 mm |



10.2 Reel with diameter of 180 mm

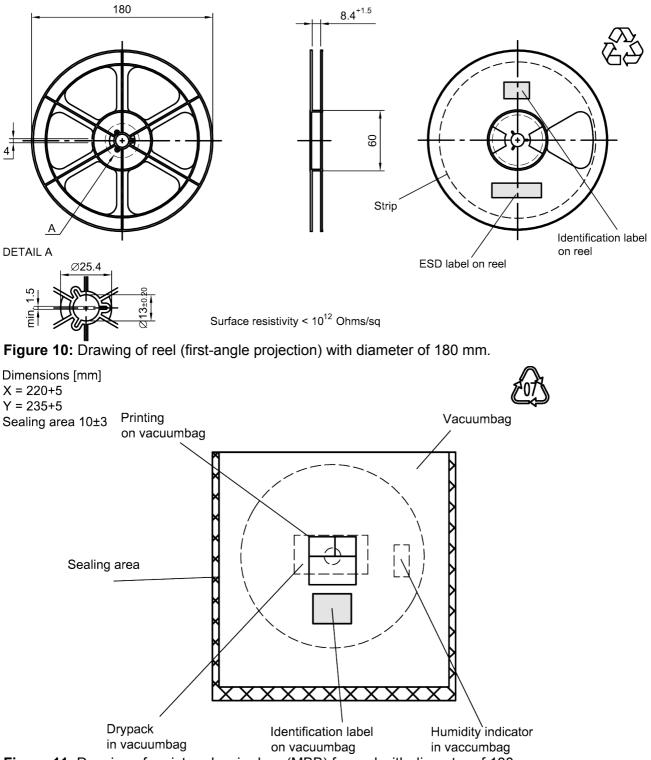


Figure 11: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

Please read **Cautions and warnings** and **Important notes** at the end of this document.

Qualcomm RF360 Europe GmbH

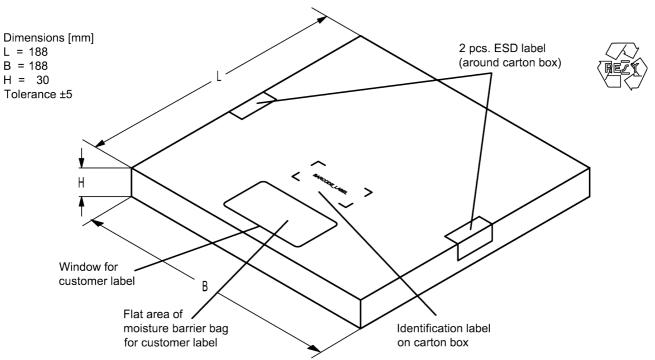
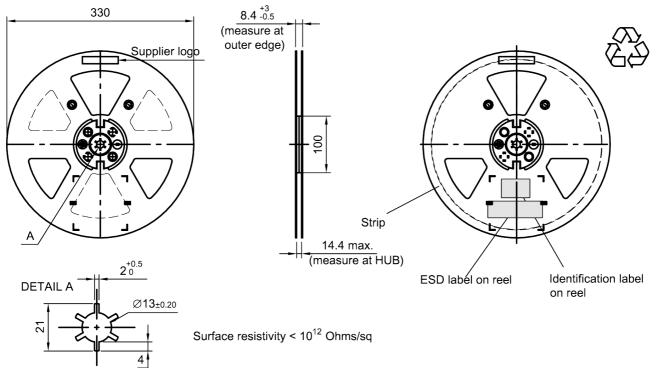
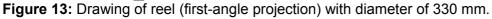


Figure 12: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm







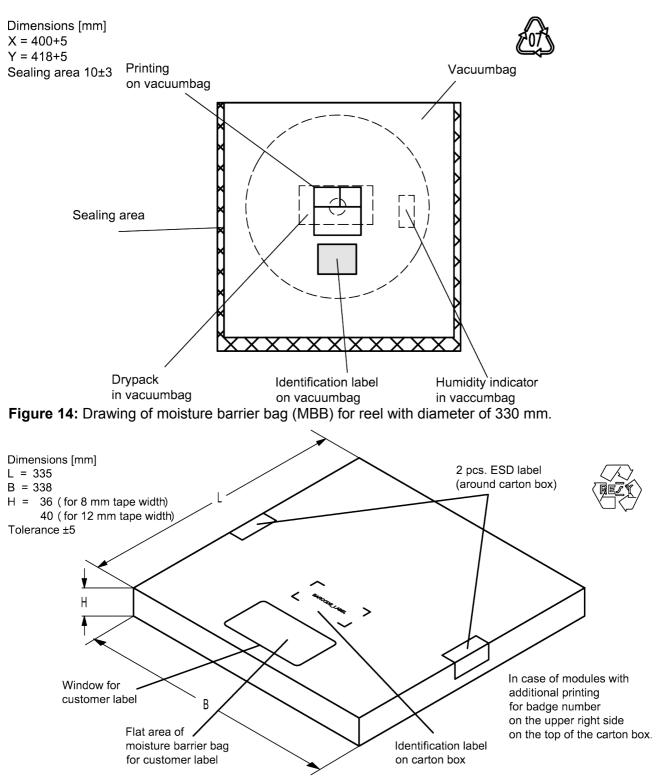


Figure 15: Drawing of folding box for reel with diameter of 330 mm.

Qualcomm RF360 Europe GmbH

11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

| The 4 digit type number o is encoded by a special B | f the ordering code, ASE32 code into a 3 digit marking. | e.g., B3xxxxB <u>1234</u> xxxx, |
|---|--|----------------------------------|
| Example of decoding 16J 1 x 32 ² + 6 x 3 The BASE32 code for pro | type number marking on device => 32 ¹ + 18 (=J) x 32 ⁰ = duct type B1261 is 17D. | in decimal code. 1234 1234 |

■ Lot number:

The last 5 digits of the lot number,e.g.,**12345**,are encoded based on a special BASE47 code into a 3 digit marking.12345,

Example of decoding lot number marking on device **5UY**

| 5UY Ő | 5 | => | 12345 |
|---------------------------------------|--|----|-------|
| 5 x 47 ² + 2 | 7 (=U) x 47 ¹ + 31 (=Y) x 47 ⁰ | = | 12345 |

| Adopted BASE32 code for type number | | | | |
|-------------------------------------|--------|---------|--------|--|
| Decimal | Base32 | Decimal | Base32 | |
| value | code | value | code | |
| 0 | 0 | 16 | G | |
| 1 | 1 | 17 | Н | |
| 2 | 2 | 18 | J | |
| 3 | 3 | 19 | K | |
| 4 | 4 | 20 | М | |
| 5 | 5 | 21 | Ν | |
| 6 | 6 | 22 | Р | |
| 7 | 7 | 23 | Q | |
| 8 | 8 | 24 | R | |
| 9 | 9 | 25 | S | |
| 10 | А | 26 | Т | |
| 11 | В | 27 | V | |
| 12 | С | 28 | W | |
| 13 | D | 29 | Х | |
| 14 | E | 30 | Y | |
| 15 | F | 31 | Z | |

| Adopted BASE47 code for lot number | | | | |
|------------------------------------|----------------|------------------|----------------|--|
| Decimal value | Base47 code | Decimal value | Base47 code | |
| 0 | 0 | 24 | R | |
| 1 | 1 | 25 | S | |
| 2 | 2 | 26 | T | |
| 3 | 3 | 27 | U | |
| 4 | 4 | 28 | V | |
| 5 | 5 | 29 | W | |
| 6 | 6 | 30 | х | |
| 7 | 7 | 31 | Y | |
| 8 | 8 | 32 | Z | |
| 9 | 9 | 33 | b | |
| 10 | A | 34 | d | |
| 11 | В | 35 | f | |
| 12 | С | 36 | h | |
| 13 | D | 37 | n | |
| 14 | E | 38 | r | |
| 15 | F | 39 | t | |
| 16 | G | 40 | v | |
| 17 | Н | 41 | ١ | |
| 18 | J | 42 | ? | |
| 19 | К | 43 | { | |
| 20 | L | 44 | } | |
| 21 | М | 45 | < | |
| 22 | N | 46 | > | |
| 23 | Р | | | |

in decimal code.

Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

| ramp rate | ≤ 3 K/s |
|------------------------------------|--|
| preheat | 125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s |
| <i>T</i> > 220 °C | 30 s to 70 s |
| <i>T</i> > 230 °C | min. 10 s |
| <i>T</i> > 245 °C | max. 20 s |
| <i>T</i> ≥ 255 °C | _ |
| peak temperature T _{peak} | 250 °C +0/-5 °C |
| wetting temperature T_{min} | 230 °C +5/-0 °C for 10 s ± 1 s |
| cooling rate | ≤ 3 K/s |
| soldering temperature T | measured at solder pads |
| | |

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

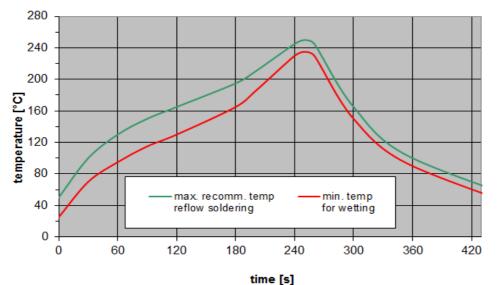


Figure 16: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.3 Ordering codes and packing units

| Ordering code | Packing unit |
|--------------------|--------------|
| B39272B1261P810S 5 | 5000 pcs |
| B39272B1261P810W 5 | 5000 pcs |

Table 4: Ordering codes and packing units.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under https://rffe.qualcomm.com/.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



15 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (<u>https://rffe.qualcomm.com</u>). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.

The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

单击下面可查看定价,库存,交付和生命周期等信息

>>Qualcomm-RF360